SGM4552
1-Bit Bidirectional Voltage-Level Translator for Open-Drain and Push-Pull Applications

GENERAL DESCRIPTION

This one-bit non-inverting translator uses two separate configurable power-supply rails. The A port is designed to track V_{CCA}. V_{CCA} accepts any supply voltage from 1.65V to 5.5V. The B port is designed to track V_{CCB}. V_{CCA} must be less than or equal to V_{CCB}. V_{CCB} accepts any supply voltage from 2.3V to 5.5V. This allows for low-voltage bidirectional translation between any of the 1.8V, 2.5V, 3.3V, and 5V voltage nodes.

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state, which significantly reduces the power-supply quiescent current consumption. OE has an internal pull-down current source, as long as V_{CCA} is powered.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pull-down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SGM4552 is available in the Green SOT-23-6, SC70-6 and UTDFN-1.45×1-6L packages. It operates over an ambient temperature range of -40℃ to +85℃.

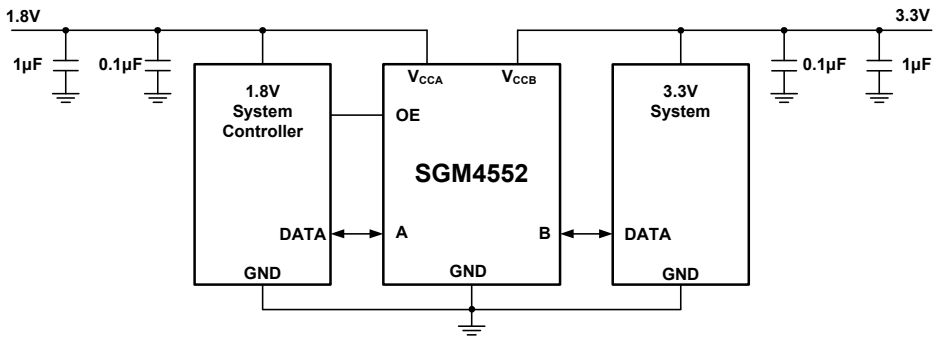
FEATURES

- **No Direction-Control Signal Needed**
- **Data Rates**
  24Mbps (Push-Pull)
  2Mbps (Open-Drain)
- **1.65V to 5.5V on A Port and 2.3V to 5.5V on B Port ($V_{CCA} \leq V_{CCB}$)**
- **V_{CC} Isolation: If Either V_{CC} is at GND, Both Ports are in the High-Impedance State**
- **No Power-Supply Sequencing Required: Either V_{CCA} or V_{CCB} can be Ramped First**
- **I_{OFF}: Supports Partial-Power-Down Mode Operation**
- **Available in Green UTDFN-1.45×1-6L, SOT-23-6 and SC70-6 Packages**

APPLICATIONS

I^2C/SMBus
UART
GPIO

TYPICAL APPLICATION CIRCUIT



PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	ORDERING NUMBER	PACKAGE MARKING	PACKAGE OPTION
SGM4552	SC70-6	SGM4552YC6G/TR	SL1XX	Tape and Reel, 3000
	SOT-23-6	SGM4552YN6G/TR	SL3XX	Tape and Reel, 3000
	UTDFN-1.45×1-6L	SGM4552YUDL6G/TR	NAX	Tape and Reel, 5000

NOTE: **X** = Date Code, **XX** = Date Code.

MARKING INFORMATION

SYY X X

Date code - Month ("A" = Jan. "B" = Feb. ⋯ "L" = Dec.)
Date code - Year ("A" = 2010, "B" = 2011 ⋯)
Chip I.D.

For example: SL1DB (2013, February)

ABSOLUTE MAXIMUM RATINGS

V_{CCA}, Supply Voltage Range..... -0.3V to 6V
V_{CCB}, Supply Voltage Range..... -0.3V to 6V
V_I, A Port, B Port, OE Input Voltage Range (2)..... -0.3V to 6V
V_O, Voltage Range Applied to Any Output in the High-Impedance or Power-Off State (2)
A Port..... -0.3V to 6V
B Port.....-0.3V to 6V
V_O, Voltage Range Applied to Any Output in the High or Low State (2) (3)
A Port.....-0.3V to V_{CCA} + 0.3V
B Port.....-0.3V to V_{CCB} + 0.3V
I_{IK}, Input Clamp Current (V_I < 0) .....-50mA
I_{OK}, Output Clamp Current (V_O < 0) .....-50mA
I_O, Continuous Output Current.....±50mA
Continuous Current through V_{CCA}, V_{CCB}, or GND.....….±100mA
Operating Temperature Range..... -40℃ to +85℃
Junction Temperature..... 150℃
Storage Temperature Range..... -65℃ to +150℃
Lead Temperature (Soldering, 10sec)..... 260℃
ESD Susceptibility
HBM.....4000V
MM.....300V

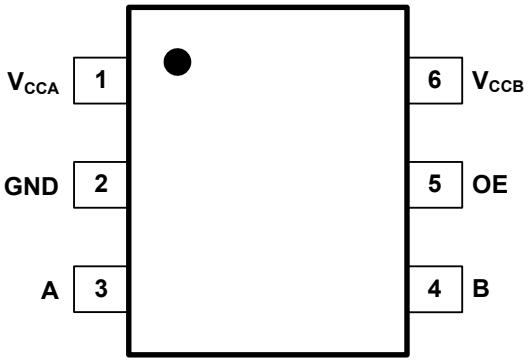
NOTES:
1. Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute Maximum rating conditions for extended periods may affect device reliability.
2. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
3. The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

CAUTION

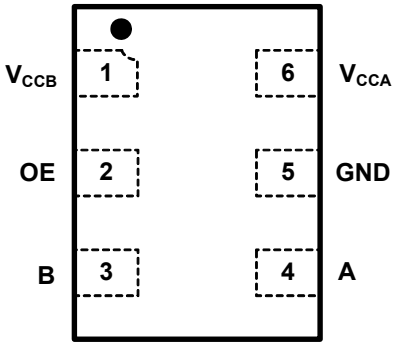
This integrated circuit can be damaged by ESD if you don’t pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the latest datasheet.

PIN CONFIGURATIONS (TOP VIEW)



SOT-23-6/SC70-6



UTDFN-1.45×1-6L

PIN DESCRIPTION

PIN		NAME	FUNCTION
SOT-23-6/SC70-6	UTDFN-1.45×1-6L		
1	6	V_{CCA}	A Port Supply Voltage. 1.65V ≤ V_{CCA} ≤ 5.5V and V_{CCA} ≤ V_{CCB}.
2	5	GND	Ground.
3	4	A	Input/Output A. Referenced to V_{CCA}.
4	3	B	Input/Output B. Referenced to V_{CCB}.
5	2	OE	Output Enable. Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA}.
6	1	V_{CCB}	B Port Supply Voltage. 2.3V ≤ V_{CCB} ≤ 5.5V.

ELECTRICAL CHARACTERISTICS

(V_{CCA} = 1.65V to 5.5V, V_{CCB} = 2.3V to 5.5V, Full = -40℃ to +85℃, typical values are at T_A = +25℃, unless otherwise noted.)

PARAMETER		CONDITIONS		TEMP	MIN	TYP	MAX	UNITS
RECOMMENDED OPERATING CONDITIONS (1) (2)								
Supply Voltage (3)	V_{CCA}			Full	1.65		5.5	V
	V_{CCB}			Full	2.3		5.5	
High-Level Input Voltage (V_{IH})	A Port I/O	V_{CCA} = 1.65V to 1.95V, V_{CCB} = 2.3V to 5.5V		Full	V_{CCI} - 0.2		V_{CCI}	V
		V_{CCA} = 2.3V to 5.5V, V_{CCB} = 2.3V to 5.5V		Full	V_{CCI} - 0.4		V_{CCI}	
	B Port I/O			Full	V_{CCI} - 0.4		V_{CCI}	
	OE Input			Full	V_{CCA} × 0.8		5.5	
Low-Level Input Voltage (V_{IL})	A Port I/O			Full	0		0.15	V
	B Port I/O			Full	0		0.15	
	OE Input			Full	0		V_{CCA} × 0.25	
Input Transition Rise or Fall Rate (Δt/ΔV)		A Port I/O Push-Pull Driving		Full			10	ns/V
		B Port I/O Push-Pull Driving		Full			10	
		Control Input		Full			10	
ELECTRICAL CHARACTERISTICS								
A Port High Level Output Voltage (V_{OHA})		I_{OH} = -20μA, V_{IB} ≥ V_{CCB} - 0.4V		Full	V_{CCA} × 0.7			V
A Port Low Level Output Voltage (V_{OLA})		I_{OL} = 1mA, V_{IB} ≤ 0.15V		Full			0.4	
B Port High Level Output Voltage (V_{OHB})		I_{OH} = -20μA, V_{IA} ≥ V_{CCA} - 0.4V		Full	V_{CCB} × 0.7			
B Port Low Level Output Voltage (V_{OLB})		I_{OL} = 1mA, V_{IA} ≤ 0.15V		Full			0.4	
Input Leakage Current (I_I)	OE			+25℃			±1	μA
				Full			±1.5	
Power Off Leakage Current (I_{OFF})	A Port	V_{CCA} = 0V, V_{CCB} = 0V to 5.5V		+25℃			±0.5	μA
				Full			±1	
	B Port	V_{CCA} = 0V to 5.5V, V_{CCB} = 0V		+25℃			±0.5	
				Full			±1	
3-State Output Leakage (I_{OZ})	A or B Port	OE = 0V		+25℃			±0.6	μA
				Full			±1	
Quiescent Supply Current (I_{CCA})		V_I = V_O = OPEN, I_O = 0	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V	Full			5.5	μA
			V_{CCA} = 5.5V, V_{CCB} = 0V	Full			5.5	
			V_{CCA} = 0V, V_{CCB} = 5.5V	Full			-1	
Quiescent Supply Current (I_{CCB})		V_I = V_O = OPEN, I_O = 0	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V	Full			15	μA
			V_{CCA} = 5.5V, V_{CCB} = 0V	Full			-1	
			V_{CCA} = 0V, V_{CCB} = 5.5V	Full			6	
Quiescent Supply Current (I_{CCA} + I_{CCB})		V_I = V_O = OPEN, I_O = 0	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V	Full			20	μA

ELECTRICAL CHARACTERISTICS

(V_{CCA} = 1.65V to 5.5V, V_{CCB} = 2.3V to 5.5V, Full = -40℃ to +85℃, typical values are at T_A = +25℃, unless otherwise noted.)

PARAMETER	CONDITIONS		TEMP	MIN	TYP	MAX	UNITS
Quiescent Supply Current (I_{CCZA})	V_I = V_{CCI} or 0V, I_O = 0, OE = 0V	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V	Full			5.5	μA
Quiescent Supply Current (I_{CCZB})	V_I = V_{CCI} or 0V, I_O = 0, OE = 0V	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V	Full			5.5	μA
OE Input Capacitance (C_I)	V_{CCA} = 3.3V, V_{CCB} = 3.3V		+25℃		4		pF
Input/Output Capacitance A Port (C_{IO})	V_{CCA} = 3.3V, V_{CCB} = 3.3V		+25℃		5		pF
Input/Output Capacitance B Port (C_{IO})					5		

NOTES:

1. V_{CCI} is the V_{CC} associated with the input port.
2. V_{CCO} is the V_{CC} associated with the output port.
3. V_{CCA} must be less than or equal to V_{CCB}, and V_{CCA} must not exceed 5.5V.

TIMING REQUIREMENTS

			V_{CCB} = 2.5V	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
			TYP	TYP	TYP	
(T_A = +25℃, V_{CCA} = 1.8V, unless otherwise noted.)						
Data Rate	Push-Pull Driving		21	22	24	Mbps
	Open-Drain Driving		2	2	2	
Pulse Duration (t_W)	Push-Pull Driving	Data Inputs	47	45	41	ns
	Open-Drain Driving		500	500	500	
(T_A = +25℃, V_{CCA} = 2.5V, unless otherwise noted.)						
Data Rate	Push-Pull Driving		20	22	24	Mbps
	Open-Drain Driving		2	2	2	
Pulse Duration (t_W)	Push-Pull Driving	Data Inputs	50	45	41	ns
	Open-Drain Driving		500	500	500	
(T_A = +25℃, V_{CCA} = 3.3V, unless otherwise noted.)						
Data Rate	Push-Pull Driving			23	24	Mbps
	Open-Drain Driving			2	2	
Pulse Duration (t_W)	Push-Pull Driving	Data Inputs		43	41	ns
	Open-Drain Driving			500	500	
(T_A = +25℃, V_{CCA} = 5V, unless otherwise noted.)						
Data Rate	Push-Pull Driving				24	Mbps
	Open-Drain Driving				2	
Pulse Duration (t_W)	Push-Pull Driving	Data Inputs			41	ns
	Open-Drain Driving				500	

SWITCHING CHARACTERISTICS

(T_A = +25℃, V_{CCA} = 1.8V, unless otherwise noted.)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V_{CCB} = 2.5V	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
				TYP	TYP	TYP	
t_{PHL}	A	B	Push-Pull Driving	2.4	3.0	4.3	ns
			Open-Drain Driving	26.0	26.3	26.7	
t_{PLH}			Push-Pull Driving	4.0	3.6	3.5	
			Open-Drain Driving	175	145	110	
t_{PHL}	B	A	Push-Pull Driving	2.0	1.9	2.1	ns
			Open-Drain Driving	26.0	26.1	26.2	
t_{PLH}			Push-Pull Driving	1.7	1.5	1.4	
			Open-Drain Driving	133	69	51	
t_{EN} (t_{PZH} & t_{PZL})	OE	A or B		24	20	18	ns
t_{DIS} (t_{PHZ} & t_{PLZ})	OE	A or B		1200	1200	1200	
t_{rA}	A Port Rise Time		Push-Pull Driving	6.6	5.8	5.4	ns
			Open-Drain Driving	89	31	10	
t_{rB}	B Port Rise Time		Push-Pull Driving	5.6	4.6	3.9	ns
			Open-Drain Driving	128	98	58	
t_{fA}	A Port Fall Time		Push-Pull Driving	2.9	2.7	2.6	ns
			Open-Drain Driving	1.9	1.7	1.6	
t_{fB}	B Port Fall Time		Push-Pull Driving	4.6	5.9	8.0	ns
			Open-Drain Driving	2.2	2.3	2.9	
Data Rate			Push-Pull Driving	21	22	24	Mbps
			Open-Drain Driving	2	2	2	

SWITCHING CHARACTERISTICS

(T_A = +25℃, V_{CCA} = 2.5V, unless otherwise noted.)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V_{CCB} = 2.5V	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
				TYP	TYP	TYP	
t_{PHL}	A	B	Push-Pull Driving	2.7	3.3	4.8	ns
			Open-Drain Driving	26.2	26.4	26.7	
t_{PLH}			Push-Pull Driving	2.6	2.4	2.3	
			Open-Drain Driving	169	144	110	
t_{PHL}	B	A	Push-Pull Driving	2.4	2.3	2.4	ns
			Open-Drain Driving	26.3	26.4	26.5	
t_{PLH}			Push-Pull Driving	2.0	1.9	1.8	
			Open-Drain Driving	165	118	55	
t_{EN} (t_{PZH} & t_{PZL})	OE	A or B		23	19	16	ns
t_{DIS} (t_{PHZ} & t_{PLZ})	OE	A or B		1200	1200	1200	
t_{rA}	A Port Rise Time		Push-Pull Driving	3.2	2.8	2.6	ns
			Open-Drain Driving	120	70	10	
t_{rB}	B Port Rise Time		Push-Pull Driving	4.5	3.4	2.6	ns
			Open-Drain Driving	122	96	62	
t_{fA}	A Port Fall Time		Push-Pull Driving	4.9	5.0	4.8	ns
			Open-Drain Driving	2.0	1.9	1.7	
t_{fB}	B Port Fall Time		Push-Pull Driving	4.8	6.1	8.3	ns
			Open-Drain Driving	1.9	2.1	2.7	
Data Rate			Push-Pull Driving	20	22	24	Mbps
			Open-Drain Driving	2	2	2	

SWITCHING CHARACTERISTICS

(T_A = +25℃, V_{CCA} = 3.3V, unless otherwise noted.)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
				TYP	TYP	
t_{PHL}	A	B	Push-Pull Driving	3.5	4.9	ns
			Open-Drain Driving	26.3	26.7	
t_{PLH}			Push-Pull Driving	2.2	2.0	
			Open-Drain Driving	133	104	
t_{PHL}	B	A	Push-Pull Driving	3.0	3.2	ns
			Open-Drain Driving	26.6	26.8	
t_{PLH}			Push-Pull Driving	1.8	1.7	
			Open-Drain Driving	132	83	
t_{EN} (t_{PZH} & t_{PZL})	OE	A or B		18	15	ns
t_{DIS} (t_{PHZ} & t_{PLZ})	OE	A or B		1200	1200	
t_{rA}	A Port Rise Time		Push-Pull Driving	2.2	2.0	ns
			Open-Drain Driving	87	36	
t_{rB}	B Port Rise Time		Push-Pull Driving	2.9	2.3	ns
			Open-Drain Driving	87	56	
t_{fA}	A Port Fall Time		Push-Pull Driving	6.2	5.8	ns
			Open-Drain Driving	2.3	2.0	
t_{fB}	B Port Fall Time		Push-Pull Driving	6.5	8.2	ns
			Open-Drain Driving	2.0	2.5	
Data Rate			Push-Pull Driving	23	24	Mbps
			Open-Drain Driving	2	2	

SWITCHING CHARACTERISTICS

(T_A = +25℃, V_{CCA} = 5V, unless otherwise noted.)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V_{CCB} = 5V	UNITS
				TYP	
t_{PHL}	A	B	Push-Pull Driving	5.4	ns
			Open-Drain Driving	26.7	
t_{PLH}			Push-Pull Driving	1.9	
			Open-Drain Driving	120	
t_{PHL}	B	A	Push-Pull Driving	5.6	ns
			Open-Drain Driving	27.3	
t_{PLH}			Push-Pull Driving	1.7	
			Open-Drain Driving	126	
t_{EN} (t_{PZH} & t_{PZL})	OE	A or B		16	ns
t_{DIS} (t_{PHZ} & t_{PLZ})	OE	A or B		1200	
t_{rA}	A Port Rise Time		Push-Pull Driving	1.8	ns
			Open-Drain Driving	79	
t_{rB}	B Port Rise Time		Push-Pull Driving	2.2	ns
			Open-Drain Driving	73	
t_{fA}	A Port Fall Time		Push-Pull Driving	8.7	ns
			Open-Drain Driving	2.7	
t_{fB}	B Port Fall Time		Push-Pull Driving	8.6	ns
			Open-Drain Driving	2.4	
Data Rate			Push-Pull Driving	24	Mbps
			Open-Drain Driving	2	

APPLICATION INFORMATION

Applications

The SGM4552 can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. The SGM4552 is ideal for use in applications where an open-drain driver is connected to the data I/Os.

Architecture

The SGM4552 architecture (see Figure 1) does not require a direction-control signal to control the direction of data flow from A to B or from B to A.

Each A port I/O has an internal 10kΩ pull-up resistor to V_{CCA}, and each B port I/O has an internal 10kΩ pull-up resistor to V_{CCB}. The output one-shots detect rising edges on the A or B ports. During a rising edge, the one-shot turns on the PMOS transistors (T1, T2) for a short duration, which speeds up the low-to-high transition.

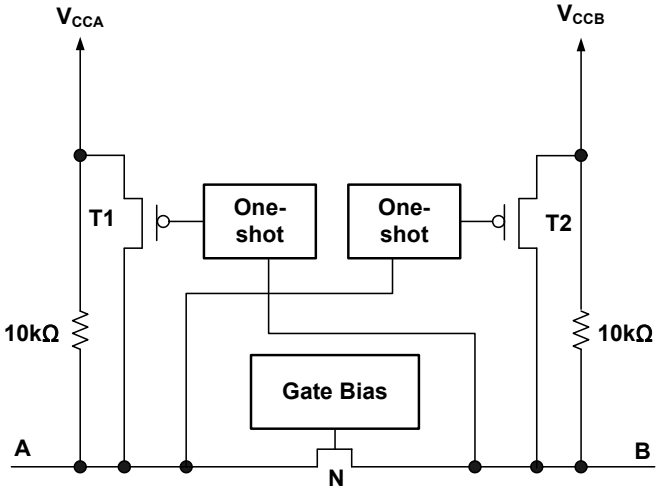


Figure 1. Architecture of an SGM4552 Cell

Input Driver Requirements

The fall time (t_{fA}, t_{fB}) of a signal depends on the output impedance of the external device driving the data I/Os of the SGM4552. Similarly, the t_{PHL} and data rates also depend on the output impedance of the external driver. The values for t_{fA}, t_{fB}, t_{PHL}, and maximum data rates in the datasheet assume that the output impedance of the external driver is less than 50Ω.

Power Up

During operation, ensure that $V_{CCA} \leq V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} > V_{CCB}$ does not damage the device, so any power supply can be ramped up first.

Output Load Considerations

We recommend careful PCB layout practices with short PCB trace lengths to avoid excessive capacitive loading and to ensure that proper one-shot (O.S.) triggering takes place. PCB signal trace-lengths should be kept short enough such that the round trip delay of any reflection is less than the one-shot duration. This improves signal integrity by ensuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 30ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic I_{CC}, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the SGM4552 output sees, so it is recommended that this lumped-load capacitance be considered to avoid O.S. retriggering, bus contention, output signal oscillations, or other adverse system-level affects.

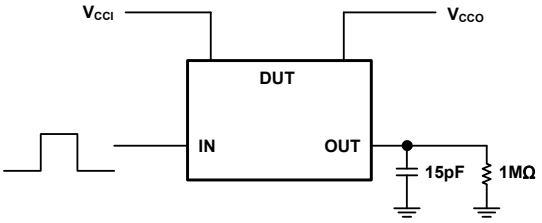
Enable and Disable

The SGM4552 has an OE input that is used to disable the device by setting OE low, which places all I/Os in the high-impedance state (Hi-Z). OE has an internal pull-down current source, as long as V_{CCA} is powered. The disable time (t_{DIS}) indicates the delay between the time when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{EN}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

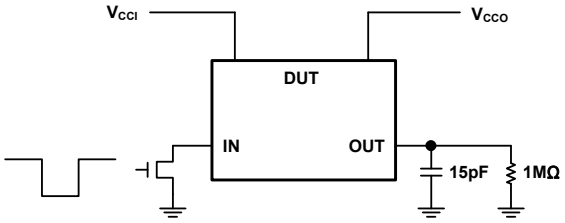
Pull-Up or Pull-Down Resistors on I/O Lines

Each A port I/O has an internal 10kΩ pull-up resistor to V_{CCA}, and each B port I/O has an internal 10kΩ pull-up resistor to V_{CCB}. If a smaller value of pull-up resistor is required, an external resistor must be added from the I/O to V_{CCA} or V_{CCB} (in parallel with the internal 10kΩ resistors).

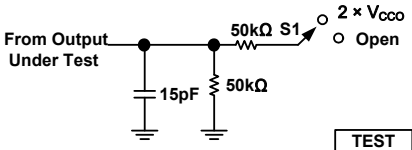
PARAMETER MEASUREMENT INFORMATION



DATA RATE, PULSE DURATION, PROPAGATION DELAY, OUTPUT RISE AND FALL TIME MEASUREMENT USING A PUSH-PULL DRIVER

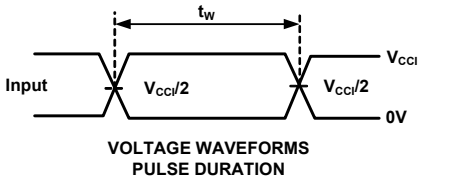


DATA RATE, PULSE DURATION, PROPAGATION DELAY, OUTPUT RISE AND FALL TIME MEASUREMENT USING AN OPEN-DRAIN DRIVER

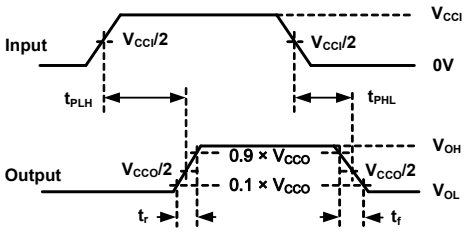


LOAD CIRCUIT FOR ENABLE/DISABLE TIME MEASUREMENT

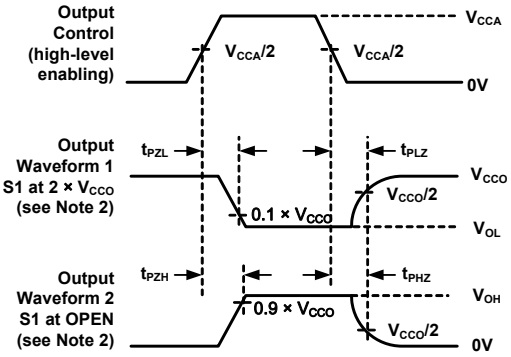
TEST	S1
t_{PZL}/t_{PLZ}	2 × V_{CCO}
t_{PHZ}/t_{PZH}	Open



VOLTAGE WAVEFORMS PULSE DURATION



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES

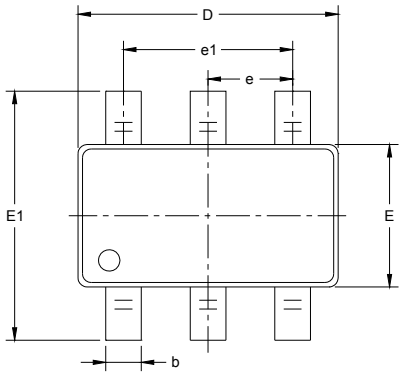
NOTES:

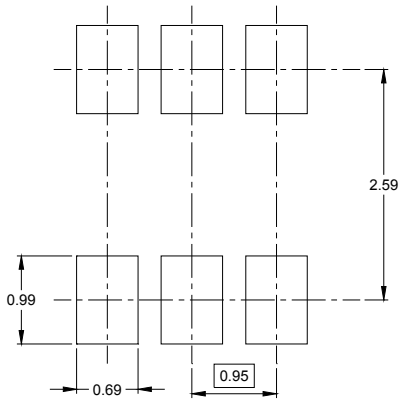
1. C_L includes probe and jig capacitance.
2. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
3. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10MHz, Z_O = 50Ω, dv/dt ≥ 1V/ns.
4. The outputs are measured one at a time, with one transition per measurement.
5. t_{PLZ} and t_{PHZ} are the same as t_{DIS}.
6. t_{PZL} and t_{PZH} are the same as t_{EN}.
7. t_{PLH} and t_{PHL} are the same as t_{PD}.
8. V_{CCI} is the V_{CC} associated with the input port.
9. V_{CCO} is the V_{CC} associated with the output port.
10. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

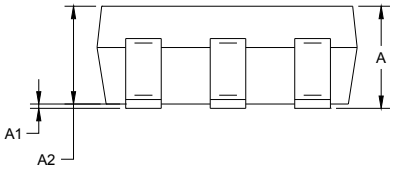
PACKAGE OUTLINE DIMENSIONS

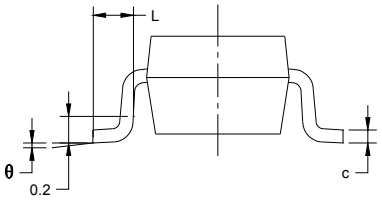
SOT-23-6





RECOMMENDED LAND PATTERN (Unit: mm)

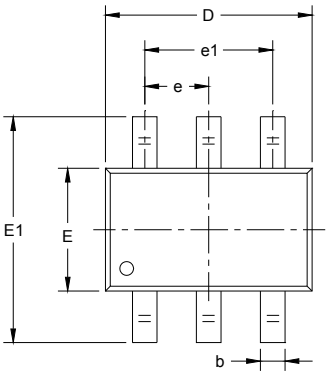


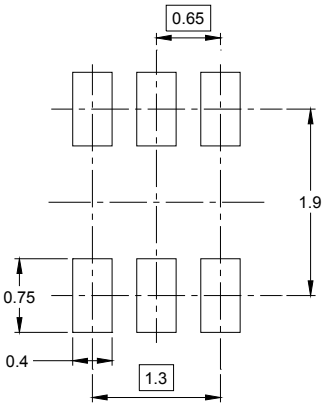


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

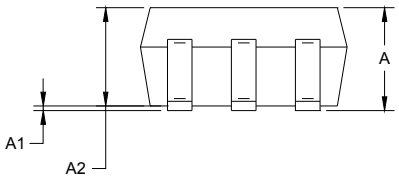
PACKAGE OUTLINE DIMENSIONS

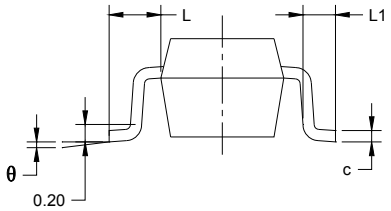
SC70-6





RECOMMENDED LAND PATTERN (Unit: mm)

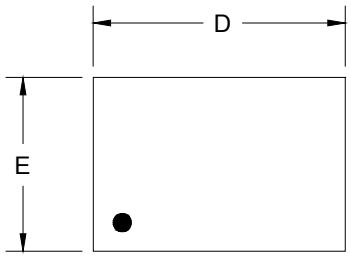




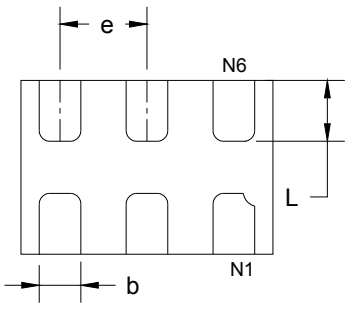
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.65 TYP		0.026 TYP	
e1	1.300 BSC		0.051 BSC	
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

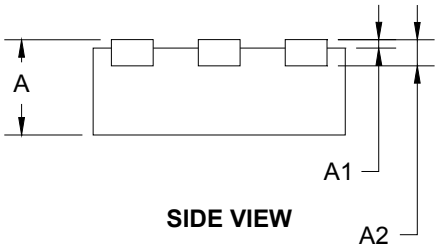
UTDFN-1.45×1-6L



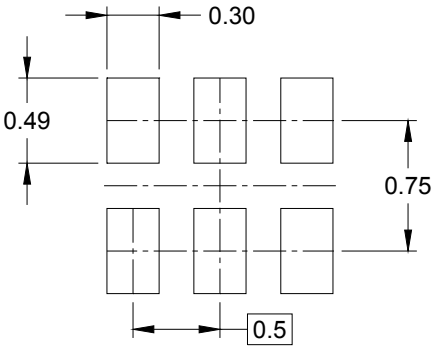
TOP VIEW



BOTTOM VIEW



SIDE VIEW

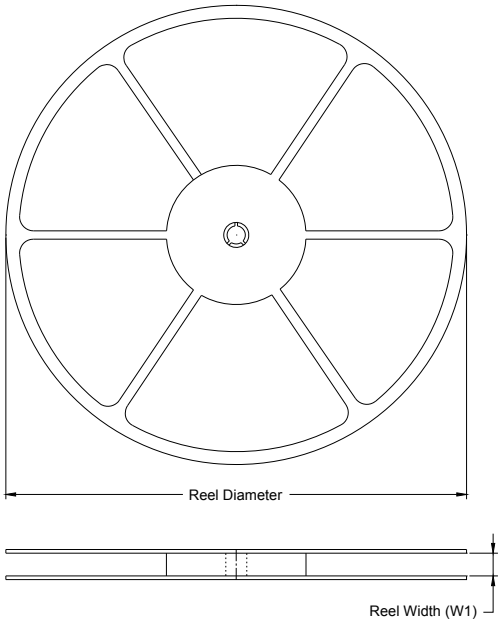


RECOMMENDED LAND PATTERN (Unit: mm)

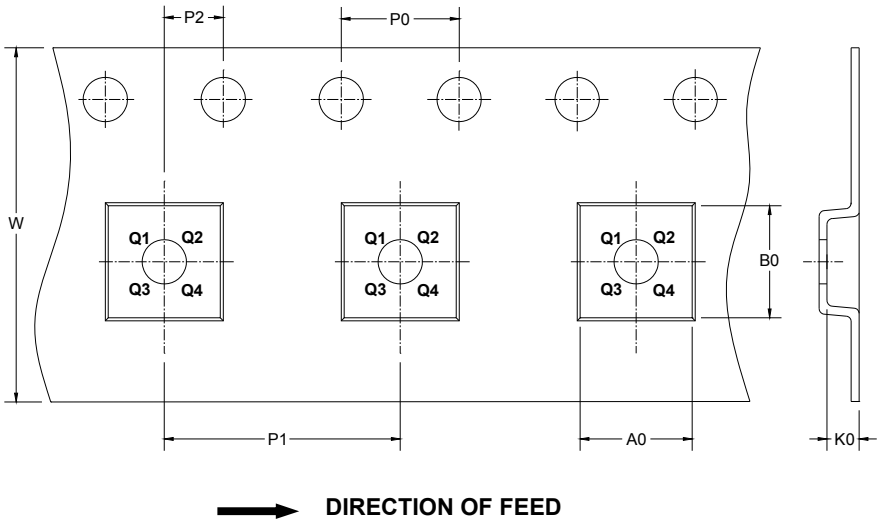
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.450	0.550	0.018	0.022
A1	0.000	0.050	0.000	0.002
A2	0.150 REF		0.006 REF	
D	1.374	1.526	0.054	0.060
E	0.924	1.076	0.036	0.042
b	0.180	0.300	0.007	0.012
e	0.500 TYP		0.020 TYP	
L	0.274	0.426	0.011	0.017

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS

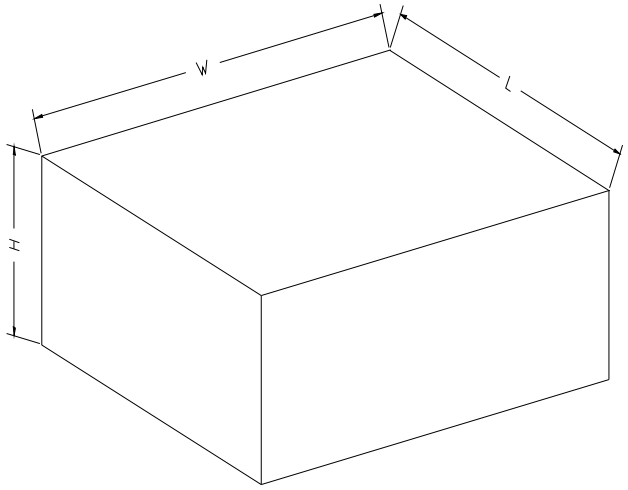


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-6	7″	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3
SC70-6	7″	9.5	2.4	2.5	1.2	4.0	4.0	2.0	8.0	Q3
UTDFN-1.45×1-6L	7″	9.5	1.15	1.6	0.75	4.00	4.00	2.00	8.00	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7″ (Option)	368	227	224	8
7″	442	410	224	18